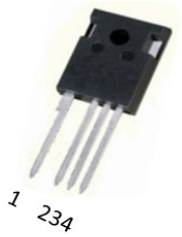
750V SiC N-Channel MOSFET

DESCRIPTION：
- High Speed Switching
- High Blocking Voltage with Low $R_{DS(ON)}$
- Easy to Parallel
- Simple to Drive
- RoHS compliant.

V_{DS}	750V
I_D	249A (Tc=25℃)
$R_{DS(ON)_typ.}$	9mΩ

TYPICAL APPLICATIONS：
- Power Factor Correction Modules
- Switch Mode Power Supplies
- DC-AC Inverters
- High Voltage DC-DC Converters



TO-247-4L

MAXIMUM RATINGS (at T_J = 25 °C, unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	750	V
Continuous Drain Current	VGS=18V Tc=25℃ Tc=100℃	I_D	 249 175	A
Peak Drain Current	Pulse width tp limited by T_{jmax}	I_{DM}	498	A
Gate-Source Voltage	tp≤0.5μs, D<0.001	V_{GSmax}	-8/+22	V
Recommend Gate-Source Voltage		V_{GSop}	-4/+18	V
Power Dissipation	Tc=25℃ Tc=100℃	P_{TOT}	739 369	W
Non-Repetitive Avalanche Switching Energy	VDD=50V, L=1mH, ID=61A	E_{AS}	1860	mJ
Operation Junction temperature		Tj	-55~+175	℃
Storage temperature		T_{STG}	-40~+150	℃

ELECTRICAL CHARATERISTICS (at T_J = 25 °C, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage VGS = 0V, ID = 100μA	$V_{(BR)DSS}$	750			V
Zero Gate Voltage Drain Current VDS = 750V, VGS = 0 V	I_{DSS}		1		uA
Gate-Source Leakage Current VGS = 18V, VDS = 0V	I_{GSS}			250	nA
Gate-Source Threshold Voltage VDS = VGS, ID = 30mA Tj=25℃ VDS = VGS, ID = 30mA Tj=175℃	$V_{GS(th)}$	2	2.9 2.1	4	V
Drain-Source On-State Resistance VGS = 18V, ID = 100A Tj=25℃ VGS = 18V, ID = 100A Tj=175℃	$R_{DS(on)}$		9.0 12		mΩ
Input capacitance f=100KHz, VDS=500 V, VGS=0 V	C_{iss}		5537		pF
Output capacitance f=100KHz, VDS=500 V, VGS=0 V	C_{oss}		392		pF
Reverse transfer capacitance f=100KHz, VDS=500 V, VGS=0 V	C_{rss}		35		pF
Internal Gate Resistance f=1MHz	$R_{G(INT)}$		5.0		Ω
Total Gate Charge VDS= 500V, ID= 100A,VGS= -4/18V	Q_G		232		nC
Gate to Source Charge VDS= 500V, ID= 100A,VGS= -4/18V	Q_{GS}		108		nC
Gate to Drain Charge VDS= 500V, ID= 100A,VGS= -4/18V	Q_{GD}		38		nC
Turn-on Delay Time VDD=500 V, ID=100A, VGS= -4/18V, RG=2.5Ω	$td_{(ON)}$		28		ns
Rise Time VDD=500 V, ID=100A, VGS= -4/18V, RG=2.5Ω	tr		40		ns
Turn-off Delay Time VDD=500 V, ID=100A, VGS= -4/18V, RG=2.5Ω	$td_{(OFF)}$		61		ns
Fall Time VDD=500 V, ID=100A, VGS= -4/18V, RG=2.5Ω	tf		17		ns
Turn-on Switching Energy VDD=500 V, ID=100A, VGS= -4/18V, RG=2.5Ω	$E_{(ON)}$		678		uJ
Turn-off Switching Energy VDD=500 V, ID=100A, VGS= -4/18V, RG=2.5Ω	$E_{(OFF)}$		971		uJ

THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Typical	Unit
Thermal resistance, junction - case		$R_{th(j-C)}$	0.20	℃/W

Body Diode

ELECTRICAL CHARATERISTICS (at T_J = 25 °C, unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Diode Forward Voltage VGS = -4V, ISD = 50A Tj=25℃ VGS = -4V, ISD = 50A Tj=175℃ VGS = -4V, ISD = 100A Tj=25℃ VGS = -4V, ISD = 100A Tj=175℃	V_{SD}		4.0 3.5 4.7 4.1		V
Continuous Diode Forward Current VGS = -4V, Tc=25℃ VGS = -4V, Tc=100℃	I_S		160 92		A
Revers Recovery Time VR=500 V, ISD=100A, VGS= -4V,di/dt = 2760A/us	Trr		21		ns
Revers Recovery Charge VR=500 V, ISD=100A, VGS= -4V,di/dt = 2760A/us	Qrr		378		nC
Peak Revers Recovery Current VR=500 V, ISD=100A, VGS= -4V,di/dt = 2760A/us	I_{rrm}		30		A

Typical Characteristics

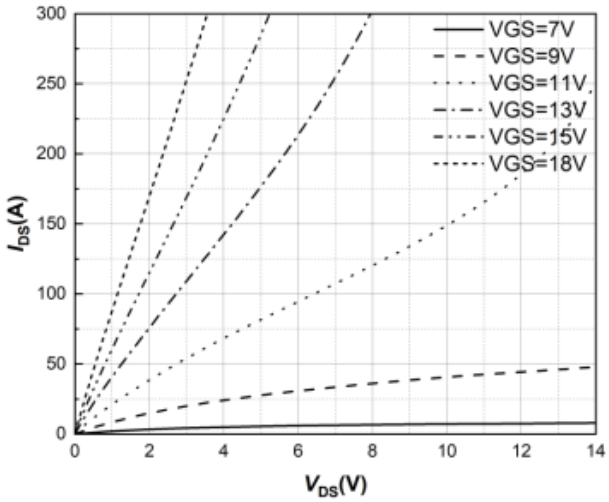


Figure 1. Output Characteristics (Tj=-55℃)

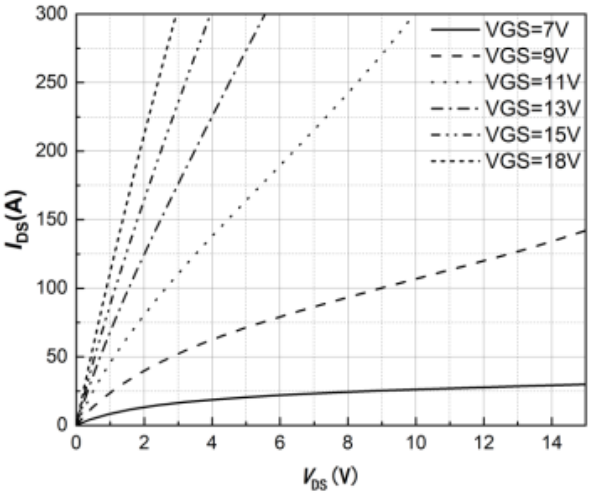


Figure 2. Output Characteristics (Tj=25℃)

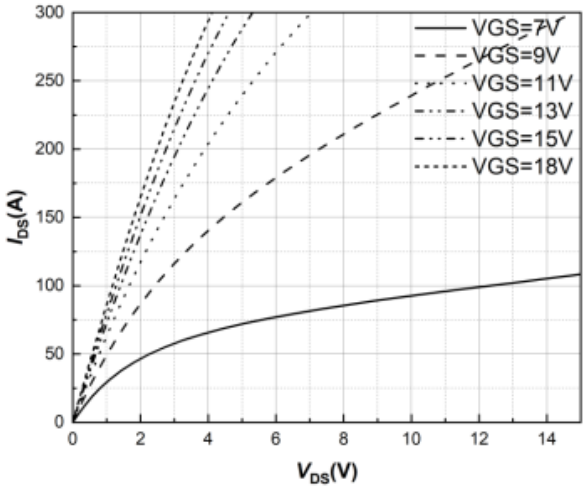


Figure 3. Output Characteristics(Tj=175℃)

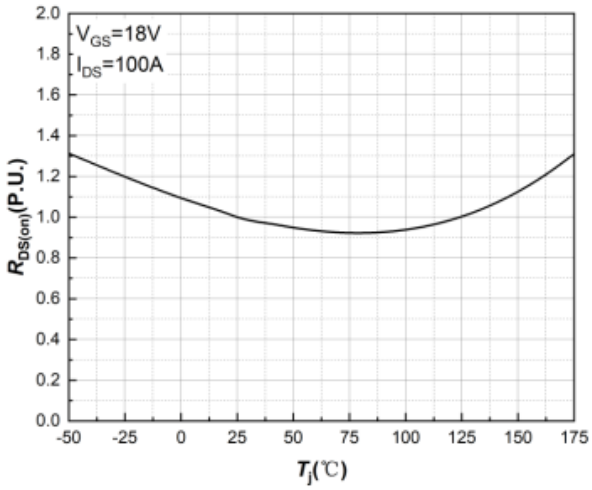


Figure 4. Normalized On-Resistance vs. Temperature

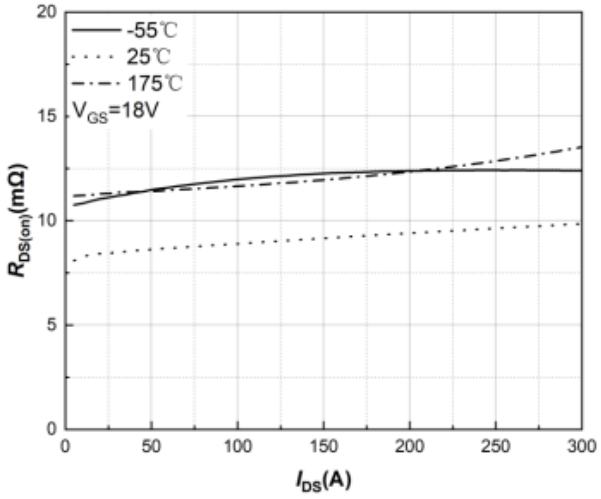


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

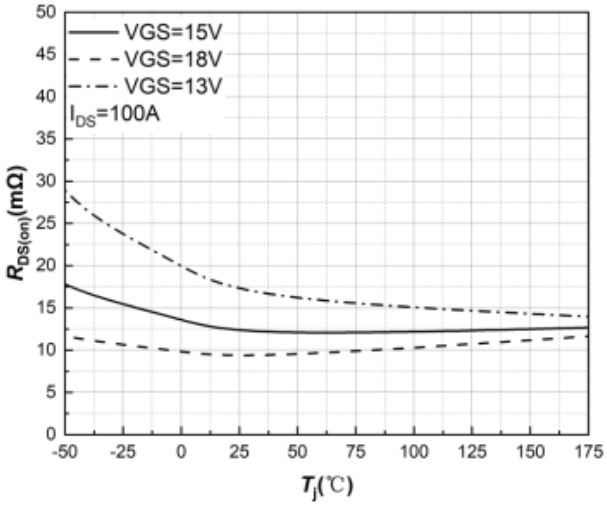


Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

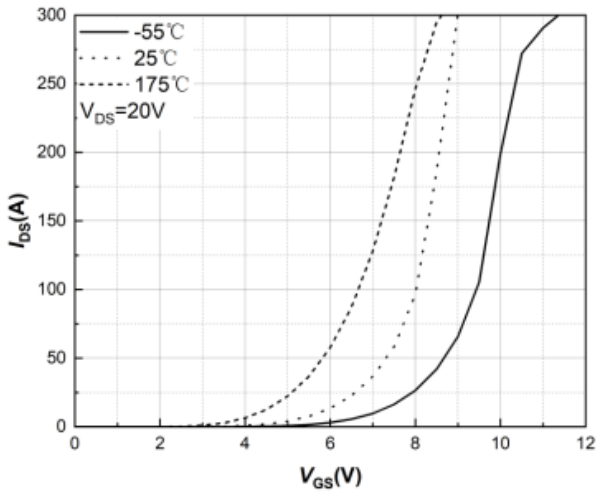


Figure 7. Transfer Characteristic for Various Junction Temperatures

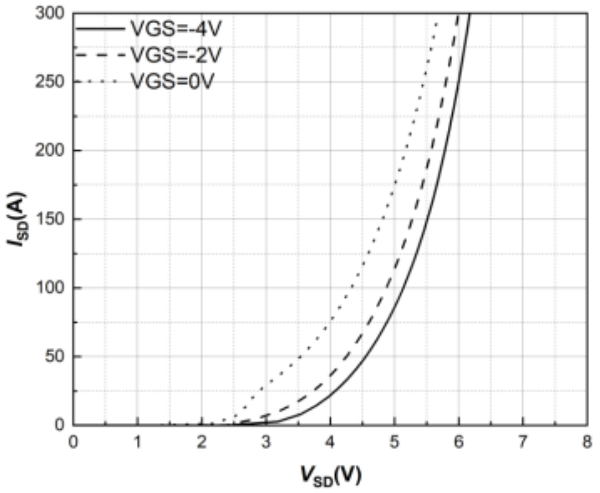


Figure 8. Body Diode Characteristic Tj=-55°C

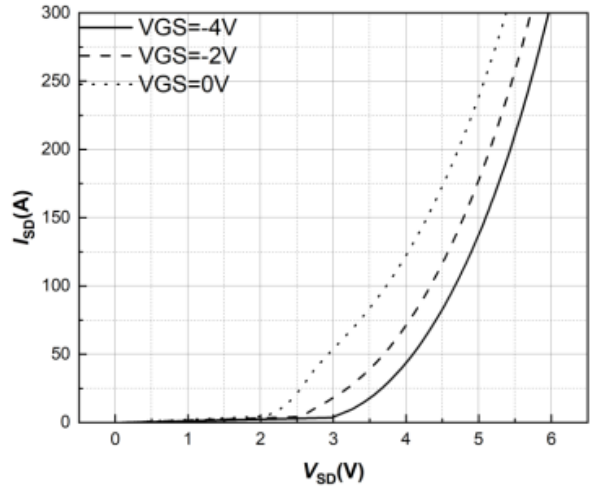


Figure 9. Body Diode Characteristic (Tj=25°C)

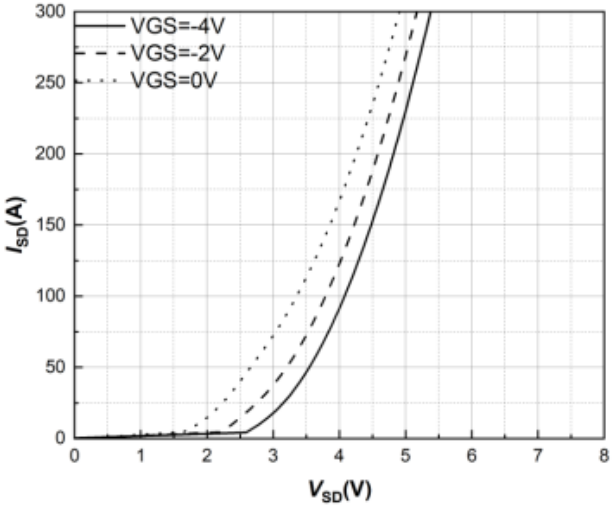


Figure 10. Body Diode Characteristic (Tj=175°C)

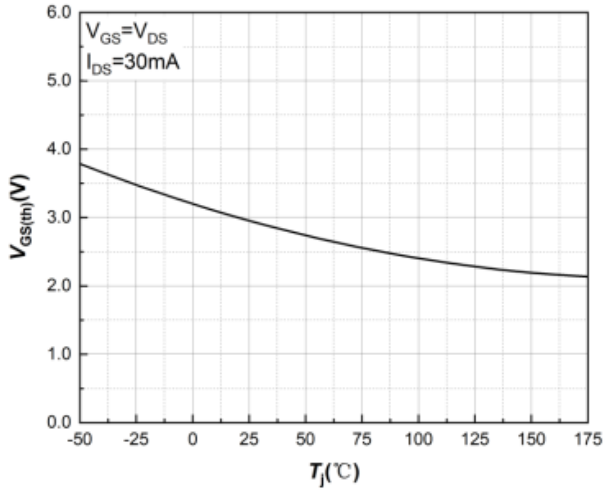


Figure 11. Threshold Voltage vs. Temperature

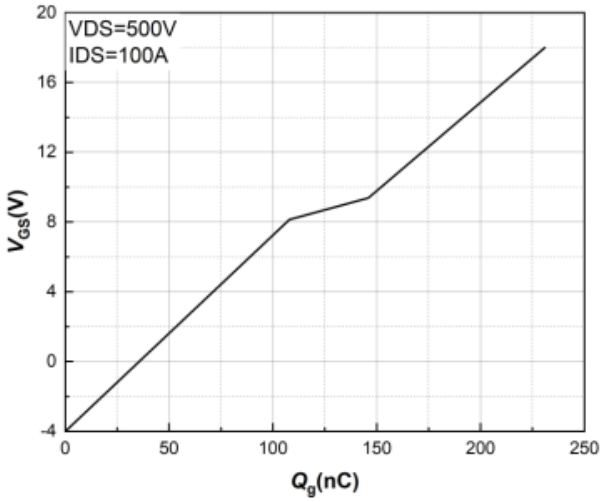


Figure 12. Gate Charge Characteristics

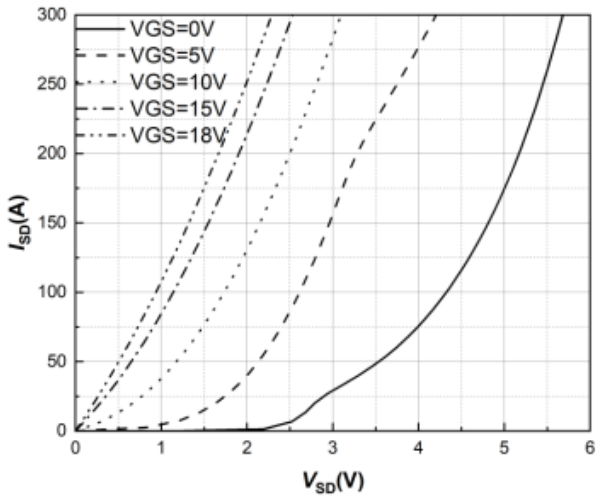


Figure 13. 3rd Quadrant Characteristic (Tj=-55°C)

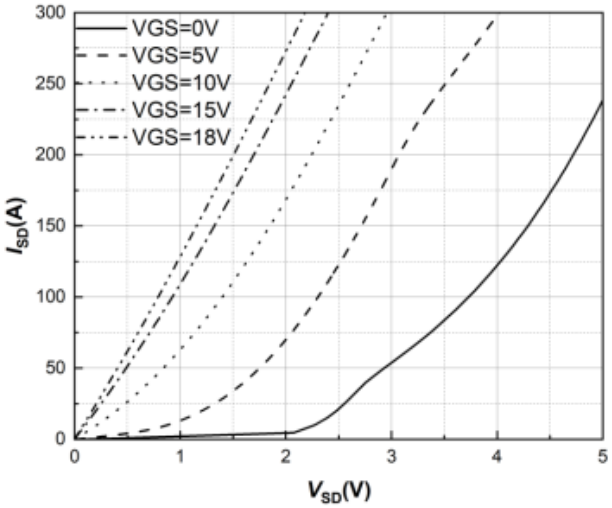


Figure 14. 3rd Quadrant Characteristic (Tj=25°C)

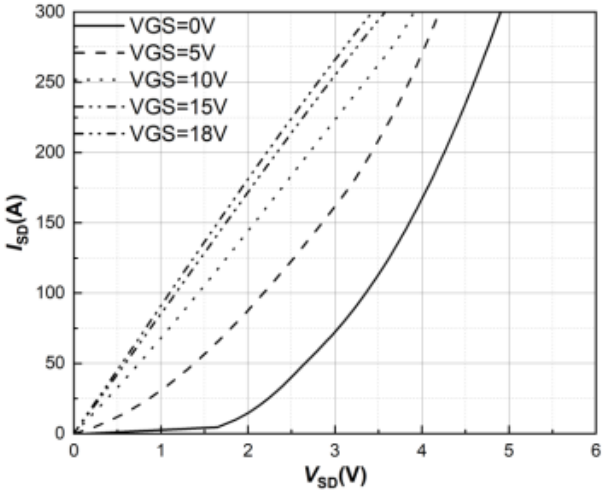


Figure 15. 3rd Quadrant Characteristic (Tj=175°C)

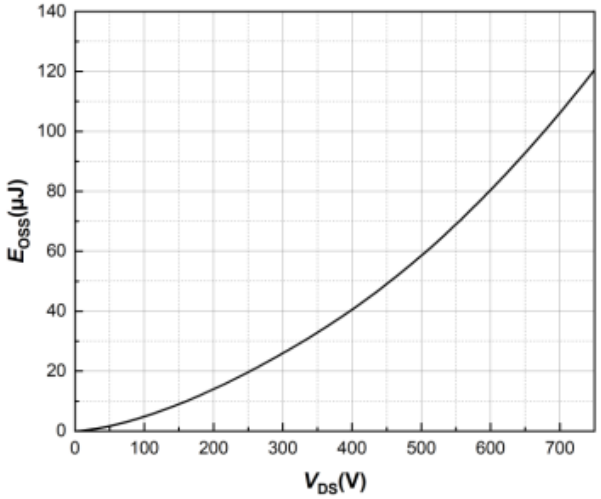


Figure 16. Output Capacitor Stored Energy

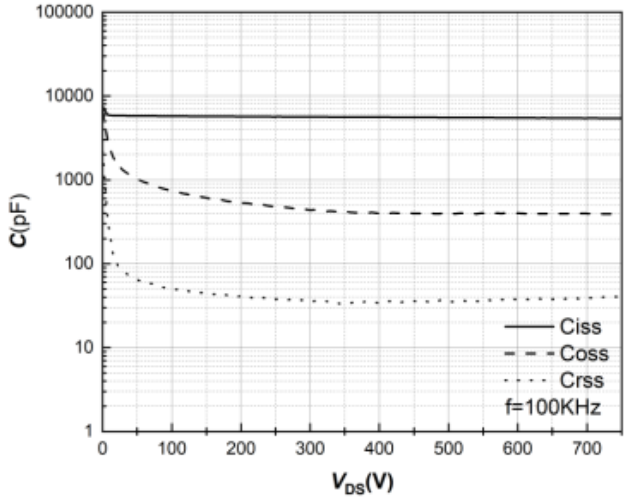


Figure 17. Capacitances vs. Drain-Source

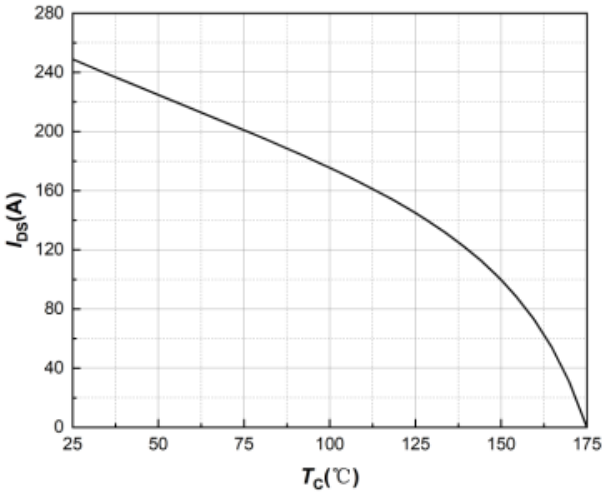


Figure 18. Continuous Drain Current Derating vs. Case Temperature

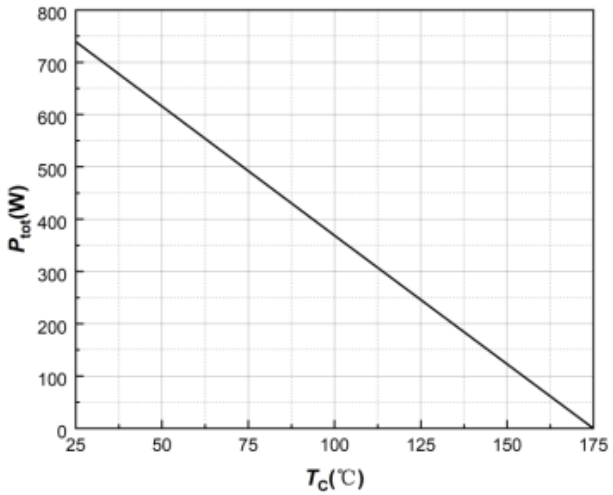


Figure 19. Maximum Power Dissipation Derating vs. Case Temperature

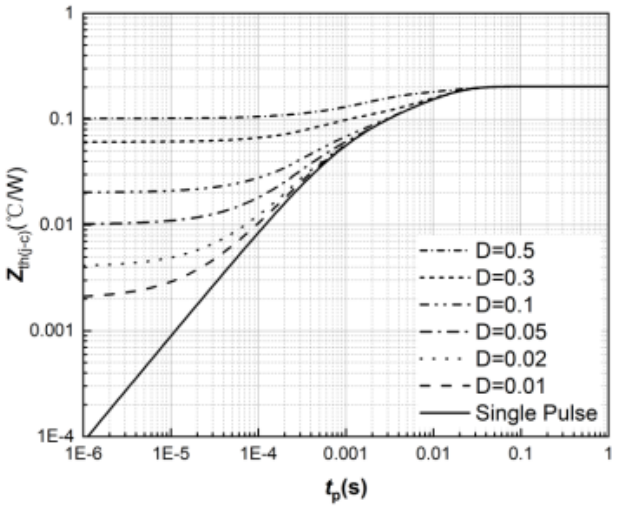


Figure 20. Transient Thermal Impedance

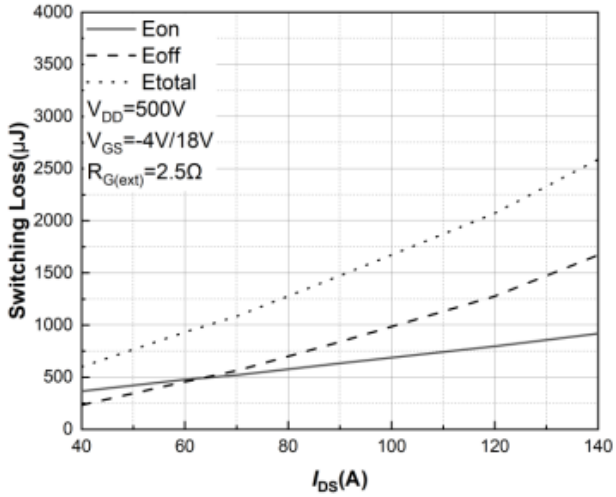


Figure 21. Clamped Inductive Switching Energy vs. Drain Current (Tj=25°C)

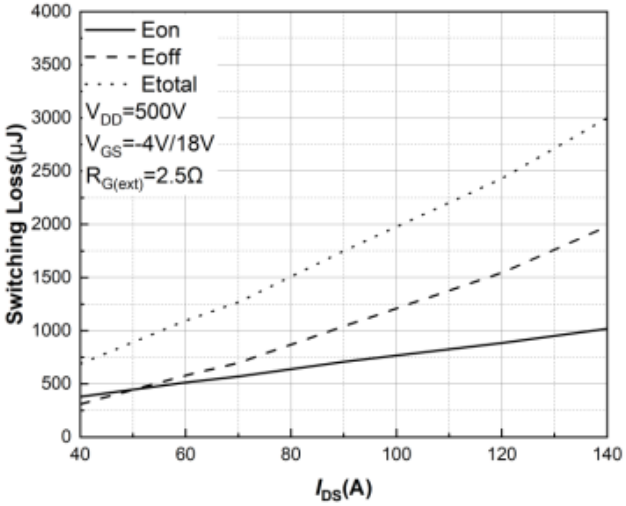


Figure 22. Clamped Inductive Switching Energy vs. Drain Current (Tj=175°C)

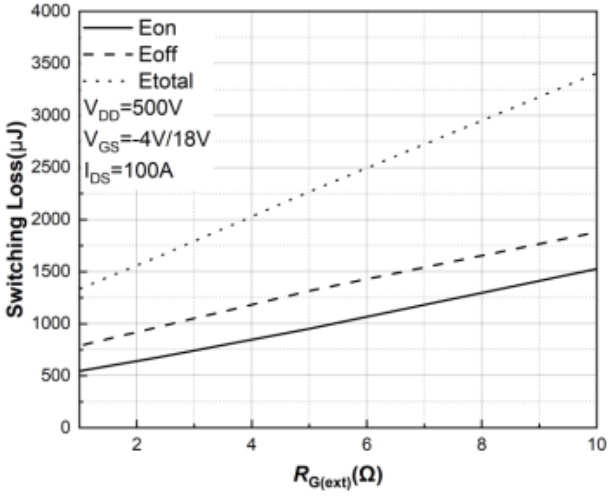


Figure 23. Clamped Inductive Switching Energy vs. RG(ext) (Tj=25°C)

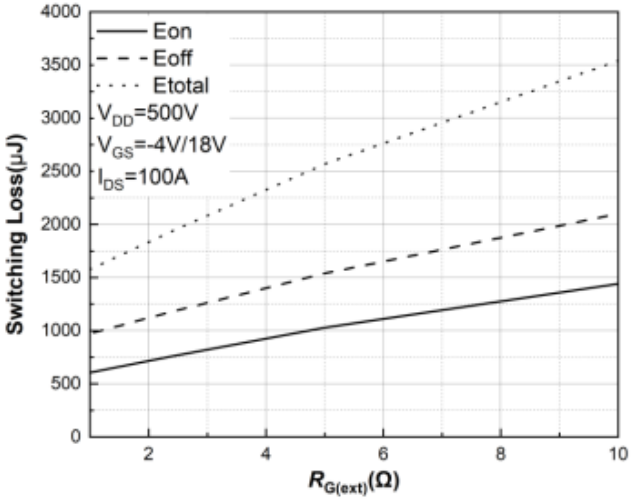


Figure 24. Clamped Inductive Switching Energy vs. RG(ext) (Tj=175°C)

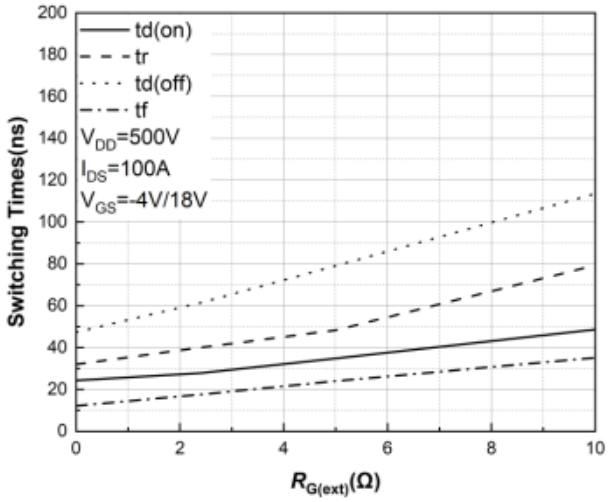


Figure 25. Switching Times vs. RG(ext) (Tj=25°C)

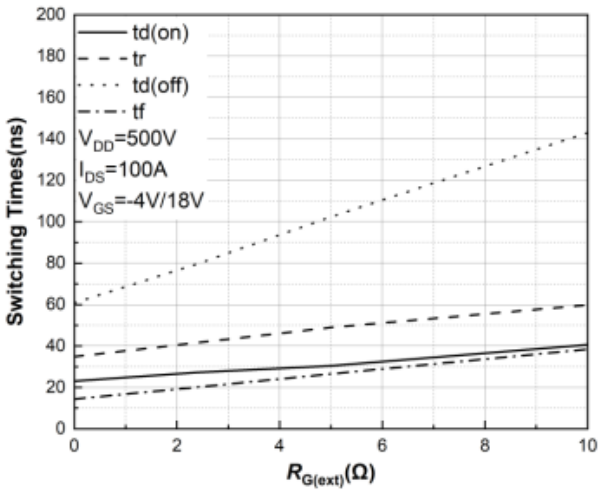


Figure 26. Switching Times vs. RG(ext) (Tj=175°C)

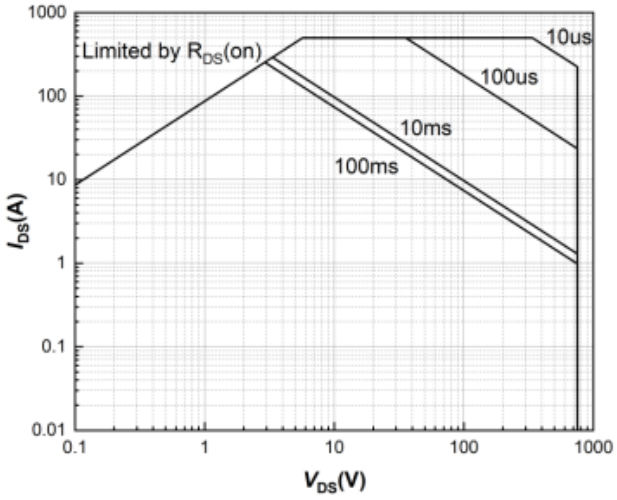
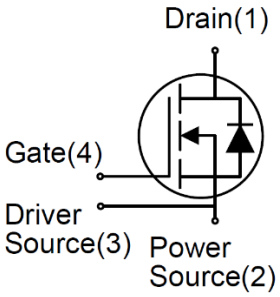
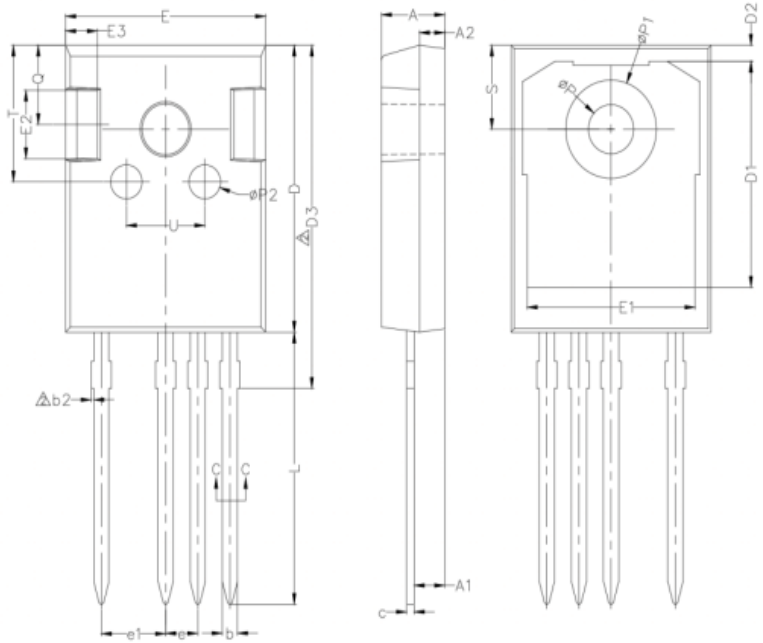


Figure 27. Safe Operating Area

• Circuit diagram



• TO-247-4L Package outlines Dimensions in (mm)



SYMBOL	Unit: mm		
	MIN	NOM	MAX
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
b	1.16	-	1.29
b2	0.00	-	0.20
c	0.59	-	0.66
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.20	1.35
D3	24.97	25.12	25.27
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
e	2.44	2.54	2.64
e1	4.98	5.08	5.18
L	19.80	19.92	20.10
P	3.50	3.60	3.70
P1	-	-	7.40
P2	2.40	2.50	2.60
Q	5.60	-	6.00
S	6.15BSC		
T	9.80	-	10.20
U	6.00	-	6.40

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